

Product Summary (@ $T_A = +25^\circ\text{C}$)

V_{RRM} (V)	I_o (A)	V_F Max (V)	I_R Max (mA)
20	0.5	0.39	0.05

Description

Packaged in the compact DFN1006 package, the Trench SBR SBRT05U20LPQ provides ultra-low forward voltage drop (V_F) and provides excellent low reverse leakage stability at high temperatures. It is ideal for use as a rectification, freewheeling or polarity protection diode.

Applications

- SMPS
- Freewheeling Diodes
- Reverse Polarity Protection
- DC-DC Converters
- General Switching Applications

Features and Benefits

- Ultra-Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented SBR® (Super Barrier Rectifier) Technology
- Soft, Fast Switching Capability
- $+150^\circ\text{C}$ Operating Junction Temperature
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Dot
- Terminals: Finish – NiPdAu over Copper Leadframe.
- Solderable per MIL-STD-202, Method 208 e4
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Top View



Bottom View

Ordering Information (Note 5)

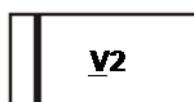
Part Number	Case	Packaging
SBRT05U20LPQ-7B	X1-DFN1006-2	10,000/Tape & Reel

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/quality/product_compliance_definitions/.
5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information

X1-DFN1006-2



V2 = Product Type Marking Code

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	20	V
DC Blocking Voltage	V_{RM}		
RMS Reverse Voltage	$V_{R(\text{RMS})}$	14	V
Average Rectified Output Current (See Figure 4)	I_O	500	mA
Non-Repetitive Peak Forward Surge Current 8.3ms	I_{FSM}	10	A
Single Half Sine-Wave Superimposed on Rated Load			

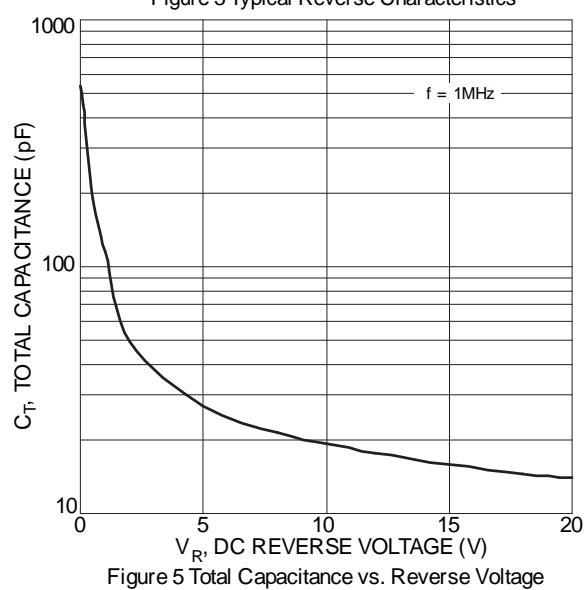
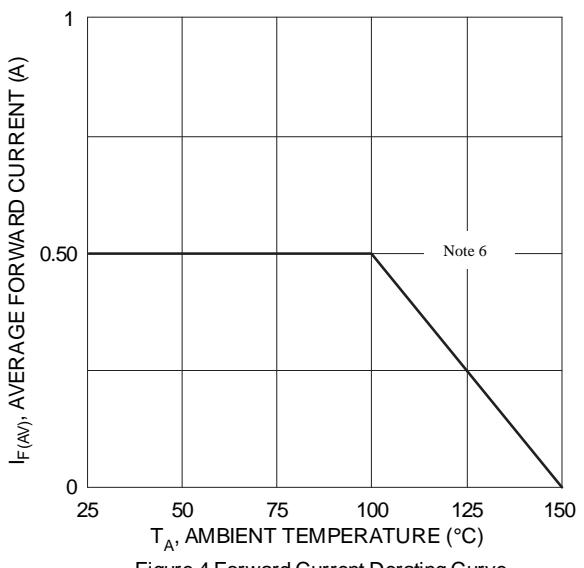
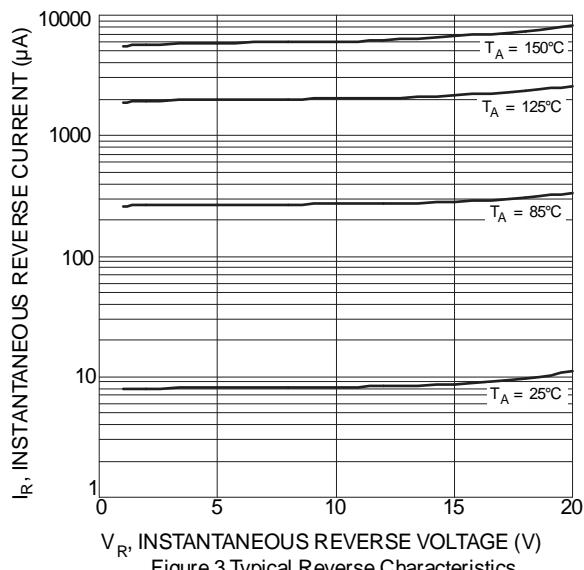
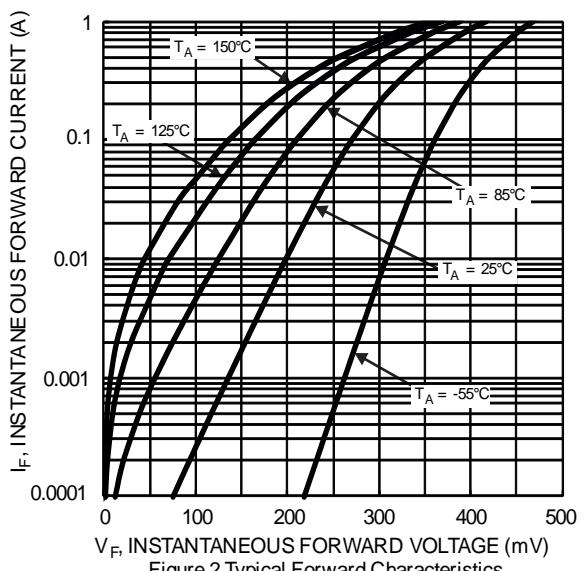
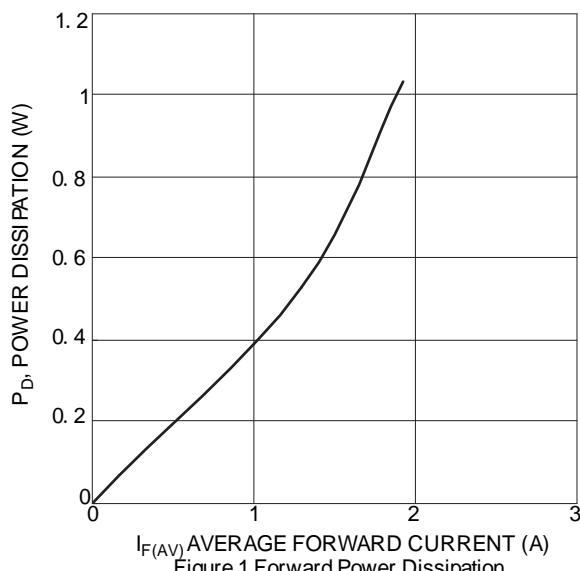
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	236	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V_F	—	0.28	0.32	V	$I_F = 0.1\text{A}, T_J = +25^\circ\text{C}$
		—	0.30	0.34		$I_F = 0.2\text{A}, T_J = +25^\circ\text{C}$
		—	0.35	0.39		$I_F = 0.5\text{A}, T_J = +25^\circ\text{C}$
Leakage Current (Note 7)	I_R	—	11	50	μA	$V_R = 20\text{V}, T_J = +25^\circ\text{C}$
		—	2.5	10		$V_R = 20\text{V}, T_J = +125^\circ\text{C}$
Total Capacitance	C_T	—	14	—	pF	$f = 1\text{MHz}, V_R = 20\text{V}$
Reverse Recovery Time	t_{RR}	—	15	—	ns	$I_F = I_R = 10\text{mA}, I_{R(\text{REC})} = 1\text{mA}$, $R_L = 100\Omega$
		—	6	—		$I_F = 500\text{mA}, di/dt = 600\text{A}/\mu\text{s}, V_R = 10\text{V}$

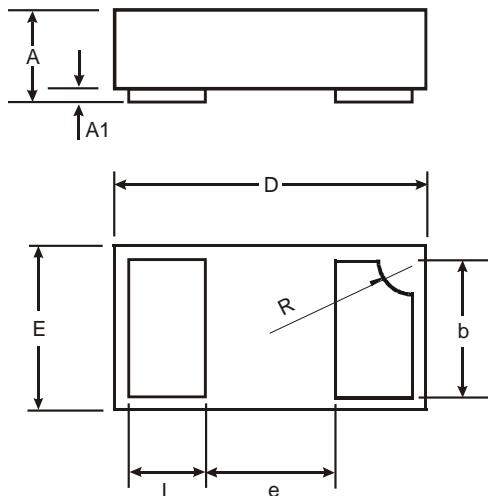
Notes: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
7. Short duration pulse test used to minimize self-heating effect.



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X1-DFN1006-2



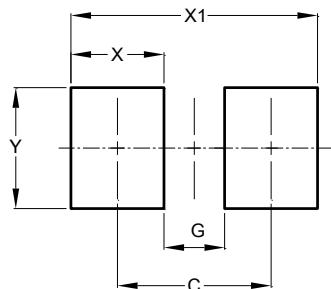
X1-DFN1006-2			
Dim	Min	Max	Typ
A	0.47	0.53	0.50
A1	0	0.05	0.03
b	0.45	0.55	0.50
D	0.95	1.075	1.00
E	0.55	0.675	0.60
e	—	—	0.40
L	0.20	0.30	0.25
R	0.05	0.15	0.10

All Dimensions in mm

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X1-DFN1006-2



Dimensions	Value (in mm)
C	0.70
G	0.30
X	0.40
X1	1.10
Y	0.70

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